# SS2FH10

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Vishay General Semiconductor

## Surface Mount Schottky Barrier Rectifier



PRIMARY CHARACTERISTICS							
I <sub>F(AV)</sub>	2.0 A						
V <sub>RRM</sub>	100 V						
I <sub>FSM</sub>	50 A						
V <sub>F</sub> at I <sub>F</sub> = 2.0 A (T <sub>A</sub> = 125 °C)	0.63 V						
T <sub>J</sub> max.	175 °C						
Package	DO-219AB (SMF)						
Diode variations	Single die						

#### FEATURES

- Low profile package
- · Ideal for automated placement
- · Low forward voltage drop, low power losses
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified available
  Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **TYPICAL APPLICATIONS**

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

#### **MECHANICAL DATA**

**Case:** DO-219AB (SMF) Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

<b>MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)								
PARAMETER	SYMBOL	SS2FH10	UNIT					
Device marking code		210						
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	100	V					
Maximum average forward rectified current (fig. 1)	I <sub>F(AV)</sub> <sup>(1)</sup>	2.0	A					
Non-repetitive peak forward surge current 8.3 ms single half sine-wave at $T_{J \text{ (init)}} = 25 ^\circ\text{C}$	I <sub>FSM</sub>	50	А					
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +175	°C					

Note

<sup>(1)</sup> Free air, mounted on recommended copper pad area

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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)								
PARAMETER	TEST	CONDITIONS	SYMBOL	TYP.	MAX.	UNIT		
Instantaneous forward voltage	I <sub>F</sub> = 1.0 A	T <sub>A</sub> = 25 °C		0.71	-	V		
	$I_{F} = 2.0 \text{ A}$	T <sub>A</sub> = 25 C	V <sub>F</sub> <sup>(1)</sup>	0.77	0.86			
	I <sub>F</sub> = 1.0 A	T <sub>A</sub> = 125 °C	VF (*)	0.56	-			
	I <sub>F</sub> = 2.0 A			0.63	0.70			
Reverse current	V 100 V	T <sub>A</sub> = 25 °C	1 (2)	-	5			
	V <sub>R</sub> = 100 V	T <sub>A</sub> = 125 °C	Ι <sub>R</sub> <sup>(2)</sup>	65	160	μA		
Typical junction capacitance	4.0 V, 1 MHz		CJ	70	-	pF		

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: Pulse width  $\leq$  5 ms

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25$ °c unless otherwise noted)						
PARAMETER	SYMBOL	SS2FH10	UNIT			
Typical thermal resistance	R <sub>0JA</sub> (1)(2)(3)	125	°C/W			
Typical mermanesistance	R <sub>0JM</sub> <sup>(2)(3)</sup>	21	0/11			

#### Notes

 $^{(1)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$ 

<sup>(2)</sup> Device mounted on FR4 PCB, 2 oz. standard footprint

 $^{(3)}$  Thermal resistance  $R_{\theta JA}$  - junction to ambient;  $R_{\theta JM}$  - junction to mount

ORDERING INFORMATION (Example)								
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE				
SS2FH10-M3/H	0.015	Н	3000	7" diameter plastic tape and reel				
SS2FH10-M3/I	0.015	I	10 000	13" diameter plastic tape and reel				
SS2FH10HM3/H (1)	0.015	Н	3000	7" diameter plastic tape and reel				
SS2FH10HM3/I <sup>(1)</sup>	0.015	l	10 000	13" diameter plastic tape and reel				

Note

(1) AEC-Q101 qualified



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#### **RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25 \text{ °C}$ unless otherwise noted)

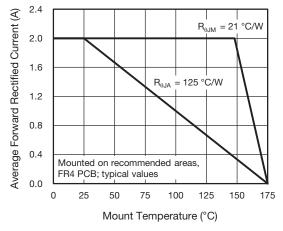


Fig. 1 - Typical Forward Current Derating Curve

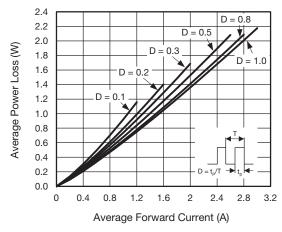


Fig. 2 - Forward Power Loss Characteristics

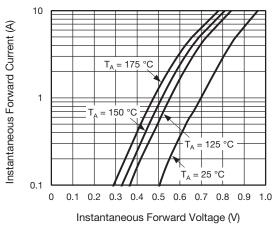


Fig. 3 - Typical Instantaneous Forward Characteristics

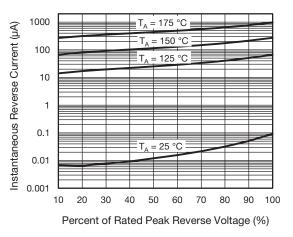
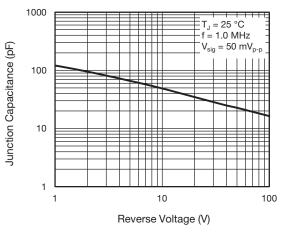
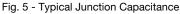


Fig. 4 - Typical Reverse Leakage Characteristics





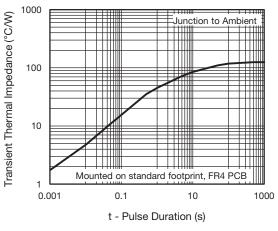


Fig. 6 - Typical Transient Thermal Impedance

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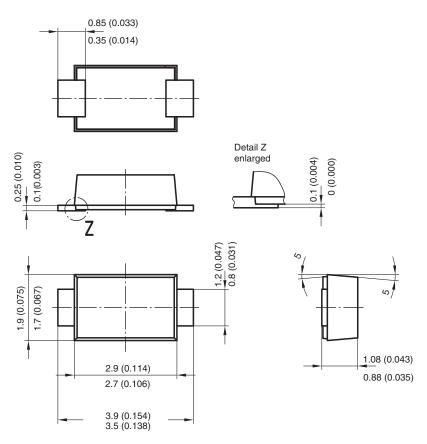
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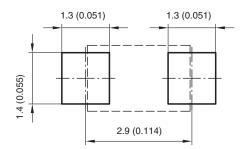


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#### **PACKAGE OUTLINE DIMENSIONS** in millimeters (inches)



Foot print recommendation:



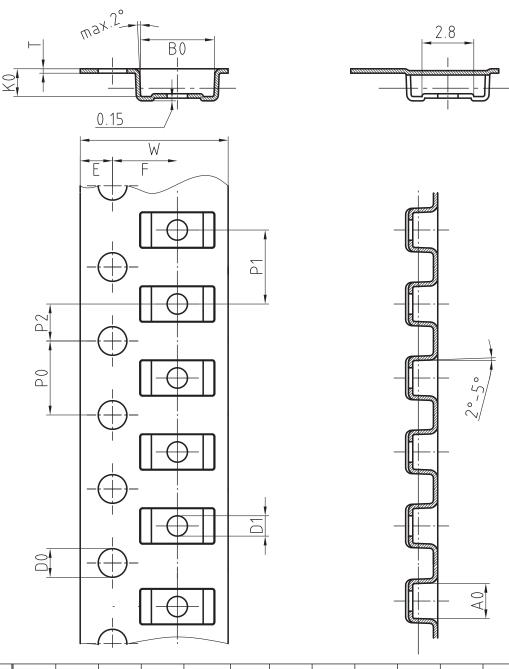
Created - Date: 15. February 2005 Rev. 3 - Date: 13. March 2007 Document no.:S8-V-3915.01-001 (4) 17247





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#### BLISTERTAPE DIMENSIONS in millimeters: DO-219AB (SMF)



Mat:	A0	B0	K0	W	Т	Ρ0	P2	P1	D0	D1	E	F
PS	1.9	4.0	1.5	8.0	0.235	4.0	2.0	4.0	1.5	1	1.75	3.5

Document-No.: S8-V-3717.02-001 (3)

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